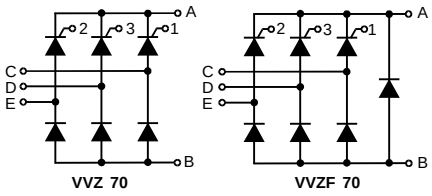
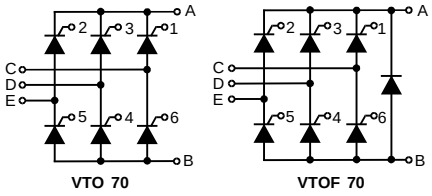
Three Phase Rectifier Bridge

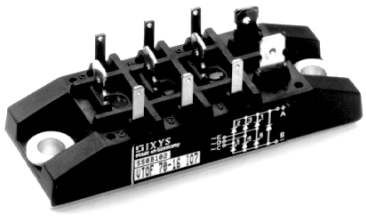
I_{dAV} = 70 A
V_{RRM} = 800-1600 V

Preliminary data

V_{RSM} V_{DSM} V	V_{RRM} V_{DRM} V	Type
800	800	xxx 70-08io7
1200	1200	xxx 70-12io7
1400	1400	xxx 70-14io7
1600	1600	xxx 70-16io7
		xxx = type







Symbol	Test Conditions		Maximum Ratings	
I_{dAV} ①	T_C = 85°C, module		70	A
I_{dAVM} ①	module		70	A
I_{FRMS}, I_{TRMS}	per leg		36	A
I_{FSM}, I_{TSM}	T_{VJ} = 45°C;	t = 10 ms (50 Hz), sine	550	A
	V_R = 0 V	t = 8.3 ms (60 Hz), sine	600	A
	T_{VJ} = T_{VJM}	t = 10 ms (50 Hz), sine	500	A
	V_R = 0 V	t = 8.3 ms (60 Hz), sine	550	A
I^2t	T_{VJ} = 45°C	t = 10 ms (50 Hz), sine	1520	A^2s
	V_R = 0 V	t = 8.3 ms (60 Hz), sine	1520	A^2s
	T_{VJ} = T_{VJM}	t = 10 ms (50 Hz), sine	1250	A^2s
	V_R = 0 V	t = 8.3 ms (60 Hz), sine	1250	A^2s
$(di/dt)_{cr}$	T_{VJ} = 125°C f = 50 Hz, t_P = 200 µs V_D = 2/3 V_{DRM}	repetitive, I_T = 50 A	150	A/µs
	I_G = 0.3 A, di_G/dt = 0.3 A/µs	non repetitive, I_T = 1/2 • I_{dAV}	500	A/µs
$(dv/dt)_{cr}$	T_{VJ} = T_{VJM}; V_{DR} = 2/3 V_{DRM} R_{GK} = ∞; method 1 (linear voltage rise)		1000	V/µs
V_{RGM}			10	V
P_{GM}	T_{VJ} = T_{VJM}	t_p = 30 µs	≤ 10	W
	I_T = I_{TAVM}	t_p = 500 µs	≤ 5	W
		t_p = 10 ms	≤ 1	W
P_{GAVM}			0.5	W
T_{VJ}			-40...+125	°C
T_{VJM}			125	°C
T_{stg}			-40...+125	°C
V_{ISOL}	50/60 Hz, RMS	t = 1 min	2500	V~
	I_{ISOL} ≤ 1 mA	t = 1 s	3000	V~
M_d	Mounting torque	(M5)	5 ± 15 %	Nm
		(10-32 UNF)	44 ± 15 %	lb.in.
Weight			50	g

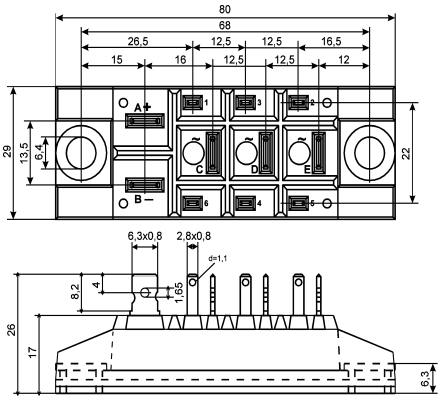
Data according to IEC 60747 refer to a single diode/thyristor unless otherwise stated
① for resistive load at bridge output. IXYS reserves the right to change limits, test conditions and dimensions.

Features
- Package with copper base plate
- Isolation voltage 3000 V~
- Planar passivated chips
- Low forward voltage drop
- ¼" fast-on power terminals

Applications
- Supplies for DC power equipment
- Input rectifiers for PWM inverter
- Battery DC power supplies
- Field supply for DC motors

Advantages
- Easy to mount with two screws
- Space and weight savings
- Improved temperature and power cycling capability
- Small and light weight

Dimensions in mm (1 mm = 0.0394")



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Symbol	Test Conditions		Characteristic Values		
I_D, I_R	$T_{VJ} = T_{VJM}$; $V_R = V_{RRM}$; $V_D = V_{DRM}$		≤	5	mA
V_T	I_T = 80 A; T_{VJ} = 25°C		≤	1.64	V
V_{T0}	For power-loss calculations only			0.85	V
r_T				11	mΩ
V_{GT}	V_D = 6 V;	T_{VJ} = 25°C	≤	1.5	V
		T_{VJ} = -40°C	≤	1.6	V
I_{GT}	V_D = 6 V;	T_{VJ} = 25°C	≤	100	mA
		T_{VJ} = -40°C	≤	200	mA
V_{GD}	$T_{VJ} = T_{VJM}$;	V_D = 2/3 V_{DRM}	≤	0.2	V
I_{GD}			≤	5	mA
I_L	T_{VJ} = 25°C; t_P = 10 µs I_G = 0.45 A; di_G/dt = 0.45 A/µs		≤	450	mA
I_H	T_{VJ} = 25°C; V_D = 6 V; R_{GK} = ∞		≤	200	mA
t_{gd}	T_{VJ} = 25°C; V_D = 1/2 V_{DRM} I_G = 0.45 A; di_G/dt = 0.45 A/µs		≤	2	µs
t_q	$T_{VJ} = T_{VJM}$; I_T = 20 A, t_P = 200 µs; di/dt = -10 A/µs V_R = 100 V; dv/dt = 15 V/µs; V_D = 2/3 V_{DRM}		typ.	250	µs
R_{thJC}	per thyristor / Diode; DC			0.9	K/W
	per module			0.15	K/W
R_{thJH}	per thyristor / Diode; DC			1.1	K/W
	per module			0.157	K/W
d_S	Creeping distance on surface			16.1	mm
d_A	Creepage distance in air			7.5	mm
a	Max. allowable acceleration			50	m/s^2